



BAT54W /AW /CW /SW

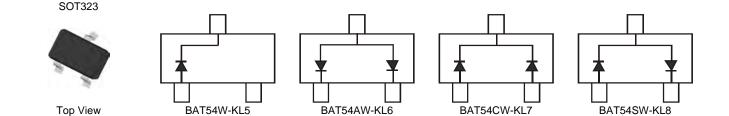
SURFACE MOUNT SCHOTTKY BARRIER DIODE

Features

- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Qualified to AEC-Q101 Standards for High Reliability
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Notes 3 & 4)

Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Diagrams Below
- Weight: 0.006 grams (approximate)



Ordering Information (Note 5)

Part Number	Case	Packaging
BAT54W-7-F	SOT323	3000/Tape & Reel
BAT54AW-7-F	SOT323	3000/Tape & Reel
BAT54AWQ-7-F	SOT323	3000/Tape & Reel
BAT54CW-7-F	SOT323	3000/Tape & Reel
BAT54SW-7-F	SOT323	3000/Tape & Reel
BAT54SWQ-7-F	SOT323	3000/Tape & Reel

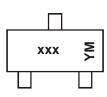
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

 Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

5. For packaging details, go to our website at http://www.diodes.com.

Marking Information



xxx = Product Type Marking Code KL5 = BAT54W KL6 = BAT54AW KL7 = BAT54CW

KL8 = BAT54SW YM = Date Code Marking Y = Year (ex: N = 2002)

M = Month (ex: 9 = September)

Date Code Key

Notes:

Year	2000	2001	2002	2003	2004		2010	2011	2012	2013	2014	2015	2016	2017	2018
Code	L	М	Ν	Р	R		Х	Y	Z	А	В	С	D	E	F
Month	Jan	Fe	b	Mar	Apr	Мау	Ju	n	Jul	Aug	Sep	Oc	t I	Nov	Dec
Code	1	2		3	4	5	6		7	8	9	0		Ν	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	V
Forward Continuous Current (Note 6)	lF	200	mA
Repetitive Peak Forward Current (Note 6)	I _{FRM}	300	mA
Forward Surge Current (Note 6) @ t < 1.0s	I _{FSM}	600	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	200	mW
Thermal Resistance Junction to Ambient Air (Note 6)	R _{θJA}	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +125	°C

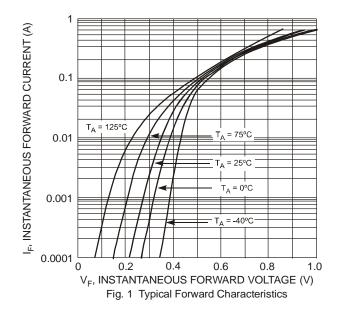
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

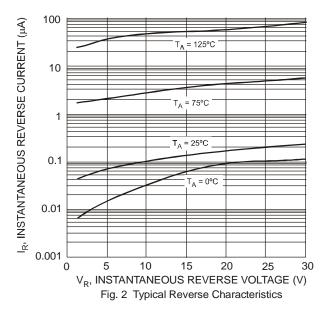
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	30	—	_	V	$I_R = 100 \mu A$
Forward Voltage	VF			240 320 400 500 1000	mV	$I_{F} = 0.1mA$ $I_{F} = 1mA$ $I_{F} = 10mA$ $I_{F} = 30mA$ $I_{F} = 100mA$
Reverse Leakage Current (Note 7)	I _R	_	_	2.0	μΑ	V _R = 25V
Total Capacitance	CT	_	_	10	pF	$V_{R} = 1.0V, f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_		5.0	ns	$I_F = 10mA$ through $I_R = 10mA$ to $I_R = 1.0mA$, $R_L = 100\Omega$

Notes:

6. 7

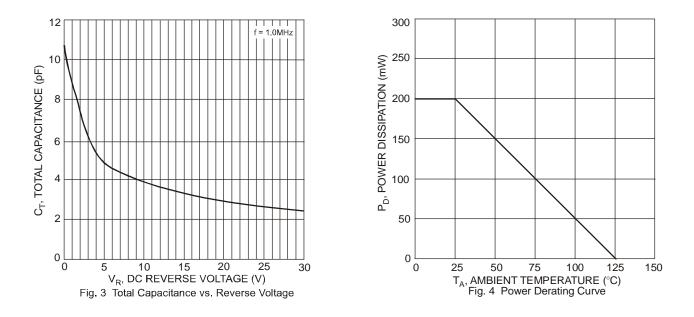
Mounted on FR-4 PC board with recommended pad layout which can be found on our website at http://www.diodes.com. Short duration pulse test used to minimize self-heating effect.





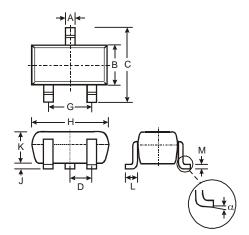


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Package Outline Dimensions

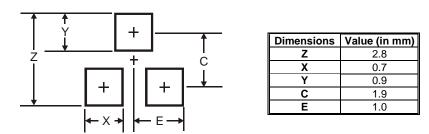
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT323								
Dim	Min Max Typ							
Α	0.25	0.40	0.30					
в	1.15	1.35	1.30					
С	2.00	2.20	2.10					
D	-	-	0.65					
G	1.20	1.40	1.30					
Н	1.80	2.20	2.15					
J	0.0	0.10	0.05					
Κ	0.90	1.00	1.00					
L	0.25	0.40	0.30					
М	0.10	0.18	0.11					
α	0°	8°	-					
All Dimensions in mm								

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.





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- 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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